

DIN EN 16602-70-07:2015-01 (E)

Space product assurance - Verification and approval of automatic machine wave soldering; English version EN 16602-70-07:2014

Contents	Page
Foreword	4
Introduction	5
1 Scope	6
2 Normative references	7
3 Terms, definitions and abbreviated terms	8
3.1 Terms from other standards.....	8
3.2 Terms specific to the present standard	8
3.3 Abbreviated terms.....	9
4 Principles	10
5 Requirements	11
5.1 General.....	11
5.1.1 PCB design constraints.....	11
5.1.2 Rework.....	11
5.2 Request for verification of the automatic wave soldering process	12
5.2.1 General	12
5.2.2 Technology samples	12
5.2.3 Examination	12
5.3 Line audit.....	13
5.4 Verification.....	13
5.4.1 Planning, management and finance	13
5.4.2 Description of samples.....	13
5.4.3 Initial tests.....	14
5.4.4 Environmental exposure	15
5.4.5 Final tests	15
5.4.6 Final verification report.....	16
5.5 Approval	16
5.5.1 Notification	16
5.5.2 Renewal of approval	16
5.5.3 Withdrawal of approval.....	16

5.5.4	Approval for future project.....	17
5.6	Process requirements for wave soldering of printed circuit boards.....	17
Annex A (normative) Solder joint discrepancy log – DRD		20
Annex B (normative) Request for verification of the automatic wave soldering process - DRD.....		22
Annex C (normative) Automatic wave soldering process verification report – DRD		24
Annex D (normative) Machine-soldering logbook – DRD		26
Annex E (normative) Wave soldering process identification document (PID) – DRD		27
Bibliography.....		28
Figures		
	Figure 4-1: Sequence of main events for final customer verification and approval of wave soldering process.....	10
	Figure A-1 : Example of a solder joint discrepancy log	21
Tables		
	Table 5-1: Limits for warp and twist	14